

N-channel 60 V, 4.6 mΩ standard level MOSFET in TO220 Rev. 3 — 18 April 2012 Product data

Product data sheet

#### **Product profile** 1.

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#### 1.1 General description

Standard level N-channel MOSFET in a TO-220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

#### 1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for standard level gate drive sources

#### 1.3 Applications

- DC-to-DC converters
- Load switching

- Motor control
- Server power supplies

#### 1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	-	60	V
I <sub>D</sub>	drain current	T <sub>mb</sub> = 25 °C; see <u>Figure 1</u>	<u>[1]</u> _	-	100	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	211	W
Tj	junction temperature		-55	-	175	°C
Static cha	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 175 °C; see <u>Figure 12</u>	-	8.05	10.6	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; see <u>Figure 13</u>	-	3.5	4.6	mΩ
Dynamic	characteristics					
Q <sub>GD</sub>	gate-drain charge	$V_{GS}$ = 10 V; I <sub>D</sub> = 25 A; V <sub>DS</sub> = 30 V;	-	14.8	-	nC
Q <sub>G(tot)</sub>	total gate charge	see Figure 14; see Figure 15	-	70.8	-	nC
Avalanch	e ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$      V_{GS} = 10 \text{ V};  \text{T}_{j(init)} = 25 \text{ °C};  \text{I}_{\text{D}} = 100 \text{ A}; \\       V_{sup} \leq 60 \text{ V};  \text{R}_{\text{GS}} = 50  \Omega; \text{ unclamped} $	-	-	266	mJ

[1] Continuous current is limited by package.



#### N-channel 60 V, 4.6 m $\Omega$ standard level MOSFET in TO220

### 2. Pinning information

Table 2.	Pinning	j information			
Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	G	gate		-	
2	D	drain	mb		
3	S	source			
mb	S source D mounting base; connected to drain			G UF A mbb076 S	
			SOT78 (TO-220AB)		

### 3. Ordering information

#### Table 3. Ordering information

Type number	Package	ge				
	Name	Description	Version			
PSMN4R6-60PS	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			

### 4. Marking

Table 4.   Marking codes	
Type number	Marking code
PSMN4R6-60PS	PSMN4R6-60PS

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N-channel 60 V, 4.6 m $\Omega$  standard level MOSFET in TO220

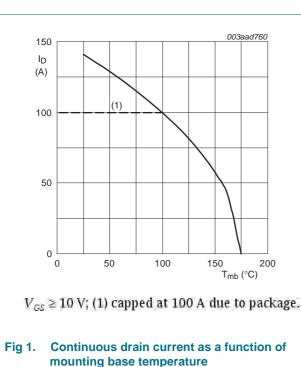
### 5. Limiting values

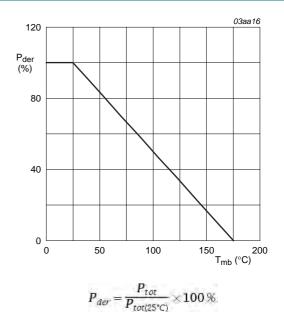
#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	60	V
V <sub>DGR</sub>	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	60	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	T <sub>mb</sub> = 100 °C; see <u>Figure 1</u>	<u>[1]</u> _	99.7	А
		T <sub>mb</sub> = 25 °C; see <u>Figure 1</u>	<u>[1]</u> _	100	А
I <sub>DM</sub>	peak drain current	pulsed; t <sub>p</sub> = 10 μs; T <sub>mb</sub> = 25 °C; see <u>Figure 3</u>	-	565	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	211	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-drai	in diode				
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	<u>[1]</u> -	100	А
I <sub>SM</sub>	peak source current	pulsed; $t_p = 10 \ \mu s$ ; $T_{mb} = 25 \ ^\circ C$	-	565	А
Avalanche r	ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$      V_{GS} = 10 \text{ V};  T_{j(init)} = 25 \text{ °C};  I_{D} = 100 \text{ A}; $	-	266	mJ

[1] Continuous current is limited by package.

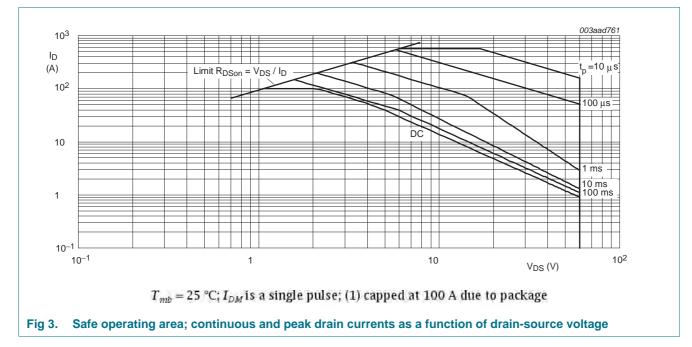






## PSMN4R6-60PS

#### N-channel 60 V, 4.6 m $\Omega$ standard level MOSFET in TO220



### 6. Thermal characteristics

#### Table 6.Thermal characteristics

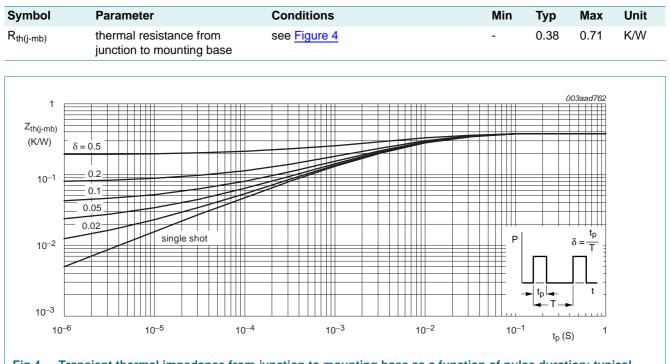


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration; typical values.

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### 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V <sub>(BR)DSS</sub> drain-source		$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$	54	-	-	V
	breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	60	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 10</u> ; see <u>Figure 11</u>	2	3	4	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 11</u>	-	-	4.6	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 175 °C; see <u>Figure 11</u>	1	-	-	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.05	10	μA
		$V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$	-	-	200	μΑ
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	10	100	nA
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	10	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 175 °C; see <u>Figure 12</u>	-	8.05	10.6	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 100 °C; see <u>Figure 12</u>	-	-	7.4	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; see <u>Figure 13</u>	-	3.5	4.6	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz	-	0.79	-	Ω
Dynamic ch	aracteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 14</u>	-	63	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 30 \text{ V}; V_{GS} = 10 \text{ V};$	-	70.8	-	nC
Q <sub>GS</sub>	gate-source charge	see Figure 14; see Figure 15	-	19.5	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge	$I_D$ = 25 A; $V_{DS}$ = 30 V; $V_{GS}$ = 10 V; see <u>Figure 14</u>	-	13.5	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge		-	6	-	nC
Q <sub>GD</sub>	gate-drain charge	$I_D = 25 \text{ A}; V_{DS} = 30 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 14</u> ; see <u>Figure 15</u>	-	14.8	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	V <sub>DS</sub> = 30 V; see <u>Figure 14;</u> see <u>Figure 15</u>	-	4.3	-	V
C <sub>iss</sub>	input capacitance	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$	-	4426	-	pF
C <sub>oss</sub>	output capacitance	$T_j = 25 \text{ °C}; \text{ see } Figure 16$	-	567	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	293	-	pF
d(on)	turn-on delay time	$V_{DS} = 30 \text{ V}; \text{ R}_{L} = 1.2 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	26	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 4.7 \ \Omega$	-	24	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	58	-	ns
t <sub>f</sub>	fall time		-	22	-	ns

Symbol

# **PSMN4R6-60PS**

Max

Unit

Тур

#### N-channel 60 V, 4.6 m $\Omega$ standard level MOSFET in TO220

Min

Source-drain dio	de						
V <sub>SD</sub> s	source-drain voltage $I_S = 25 \text{ A}; V_{GS} = 0 \text{ V};$ see <u>Figure 17</u>		; T <sub>j</sub> = 25 °C;	-	0.81	1.1	V
t <sub>rr</sub> re	everse recovery time	$I_{S} = 25 \text{ A}; dI_{S}/dt = -1$	00 A/µs; V <sub>GS</sub> = 0 V;	-	45	-	ns
Q <sub>r</sub> re	ecovered charge	V <sub>DS</sub> = 30 V		-	64	-	nC
100 ID (A) 80 60 40 20 0 0 0		003aad763	$T_{j} = 2$	40 60	80	003aad769	
	characteristics: drain of drain-source volt		Fig 6. Forward trans drain current;			functio	n of
100		003aad765	8000		0	03aad764	
I <sub>D</sub>			С				
(A) 80			(pF)		-	C <sub>iss</sub> —	
		<i>_</i>	6000				
60		4				0	
			4000		_	C <sub>rss</sub>	
20	T <sub>j</sub> = 175 °C	T <sub>j</sub> = 25 °C	2000				
0			0				
0	2 4	6 V <sub>GS</sub> (V)	0 4		8 V <sub>G</sub>	s (V) 12	
	$V_{DS} > I_D \times R_{DSon}$		f = 1	MHz; $V_{DS}$	=0 V		
	r characteristics: dra of gate-source volta		Fig 8. Input and reve function of gat	erse transfe te-source	er capa voltage,	citances typical	as a values

#### Table 7. Characteristics ...continued

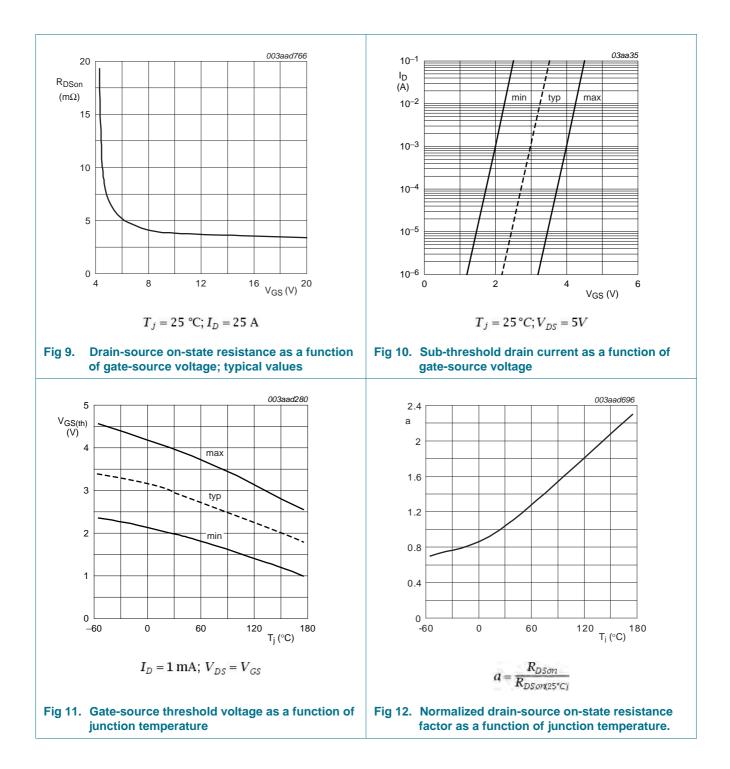
Parameter

Conditions

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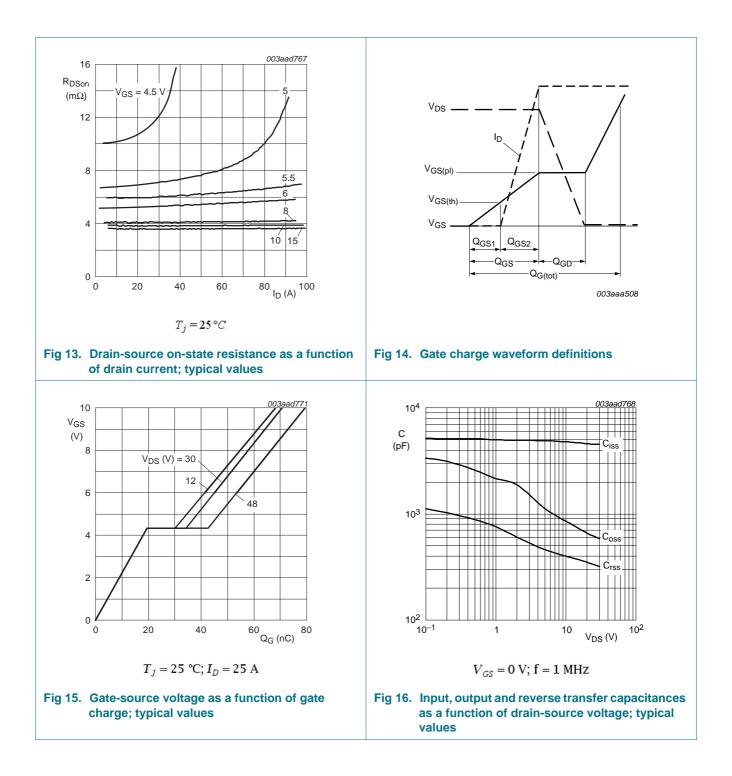
# PSMN4R6-60PS

#### N-channel 60 V, 4.6 m $\Omega$ standard level MOSFET in TO220



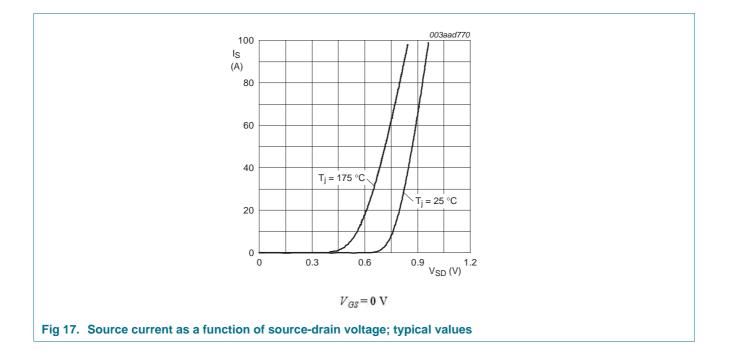
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#### N-channel 60 V, 4.6 m $\Omega$ standard level MOSFET in TO220



# **PSMN4R6-60PS**

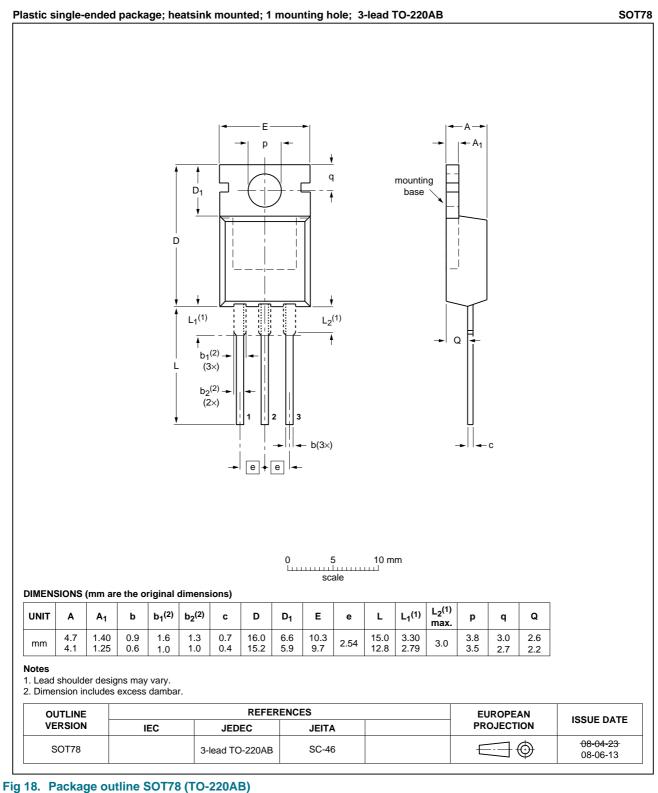
#### N-channel 60 V, 4.6 m $\Omega$ standard level MOSFET in TO220



### **PSMN4R6-60PS**

N-channel 60 V, 4.6 mΩ standard level MOSFET in TO220

#### **Package outline** 8.



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### 9. Revision history

Table 8. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN4R6-60PS v.3	20120418	Product data sheet	-	PSMN4R6-60PS v.2
Modifications:	<ul> <li>Various changes</li> </ul>	to content.		
PSMN4R6-60PS v.2	20101101	Product data sheet	-	PSMN4R6-60PS v.1

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### **10. Legal information**

#### 10.1 Data sheet status

Document status[1] [2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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